STL13DP10F6



Dual P-channel 100 V, 0.136 Ω typ., 3.3 A STripFET™ VI DeepGATE™ Power MOSFET in a PowerFLAT™ 5x6 double island

Datasheet - production data

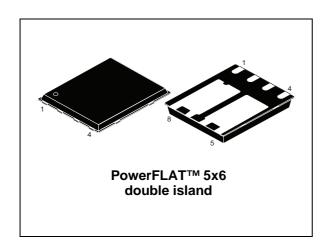
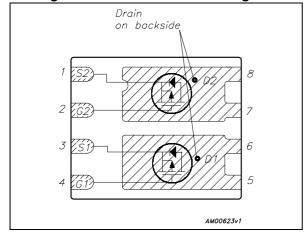


Figure 1. Internal schematic diagram



Features

Order code	V_{DS}	R _{DS(on)} max.	I _D
STL13DP10F6	100 V	0.18 Ω	3.3 A

- R_{DS(on)} * Q_q industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

Applications

· Switching applications

Description

This device is a dual P-channel Power MOSFET developed using the 6^{th} generation of STripFETTM DeepGATETM technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest $R_{DS(on)}$ in all packages.

Table 1. Device summary

Order code	Marking	Packages	Packaging
STL13DP10F6	13DP10F6	PowerFLAT™ 5x6 double island	Tape and reel

Contents STL13DP10F6

Contents

1	Electrical ratings	3
2	Electrical characteristics	4
	2.1 Electrical characteristics (curves)	6
3	Test circuits	8
4	Package mechanical data	9
5	Revision history 1	13

STL13DP10F6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	100	V
V _{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	13	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	7.3	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 25 °C	3.3	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} =100°C	2	Α
I _{DM} ⁽²⁾ , ⁽³⁾	Drain current (pulsed)	13.2	Α
P _{TOT} (1)	Total dissipation at T _C = 25°C	62.5	W
P _{TOT} (2)	Total dissipation at T _{pcb} = 25°C	4	W
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} The value is rated according R_{thj-c}

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-pcb	32	°C/W

^{1.} When mounted on FR-4 board of 1inch 2 , 2oz Cu, t < 10 sec

Note:

For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.

^{2.} The value is rated according $R_{\mbox{\scriptsize thj-pcb}}$

^{3.} Pulse width limited by safe operating area

Electrical characteristics STL13DP10F6

2 Electrical characteristics

(T_{CASE}=25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 250 \mu\text{A}$	100			٧
	Zaro goto voltogo droja	$V_{GS} = 0, V_{DS} = 100 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0$, $V_{DS} = 100 \text{ V}$, $T_{C} = 125 \text{ °C}$			10	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	٧
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 1.7 A		0.136	0.18	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	864	-	pF
C _{oss}	Output capacitance	V _{DS} =25 V, f=1 MHz,	-	45	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} =0	-	25	-	pF
Qg	Total gate charge	V _{DD} =50 V, I _D = 3.3 A	-	16.5	-	nC
Q_{gs}	Gate-source charge	V _{GS} =10 V	-	3.5	-	nC
Q_{gd}	Gate-drain charge	(see Figure 14)	-	3.8	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	10.5	-	ns
t _r	Rise time	V_{DD} =50 V, I_{D} = 1.7 A, R_{G} =4.7 Ω , V_{GS} =10 V (see Figure 13)	-	4.8	-	ns
t _{d(off)}	Turn-off delay time		-	24	-	ns
t _f	Fall time	,	-	4.5	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		3.3	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		13.2	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 3.3 \text{ A, V}_{GS} = 0$	-		1.1	٧
t _{rr}	Reverse recovery time	I _{SD} = 3.3 A,	-	26.5		ns
Q _{rr}	Reverse recovery charge	$di/dt = 100 A/\mu s,$	-	36.5		nC
I _{RRM}	Reverse recovery current	V _{DD} =80 V, T _j =150 °C	-	2.7		Α

^{1.} Pulse width limited by safe operating area

Note: For the P-channel Power MOSFET the actual polarity of the voltages and the current must be reversed.



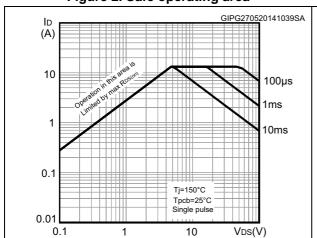
^{2.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

Electrical characteristics STL13DP10F6

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance



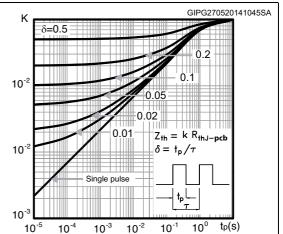
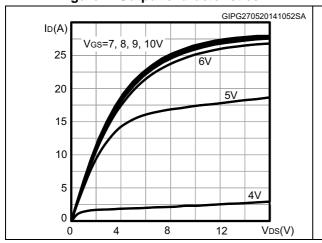


Figure 4. Output characteristics

Figure 5. Transfer characteristics



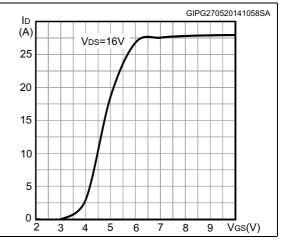
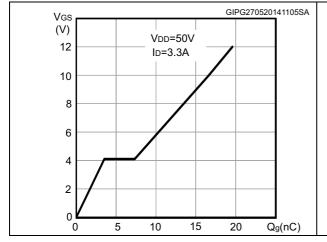
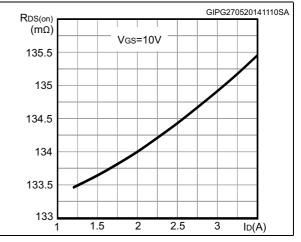


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance

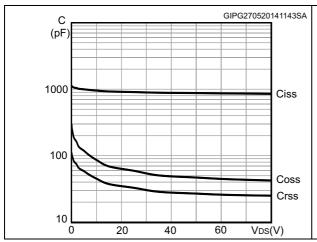




STL13DP10F6 Electrical characteristics

Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature



VGS(th) GIPG270520141144SA (norm)

1.1

0.9

0.8

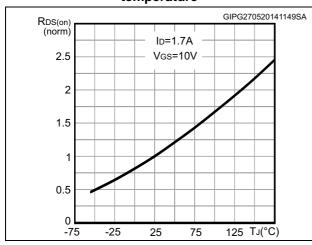
0.7

0.6

-75 -25 25 75 125 ΤJ(°C)

Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized $V_{(BR)DSS}$ vs temperature



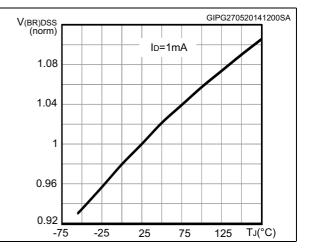
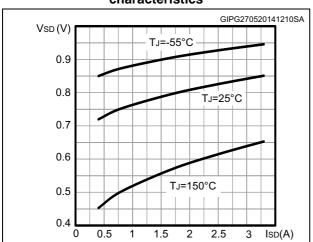


Figure 12. Source-drain diode forward characteristics



Test circuits STL13DP10F6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

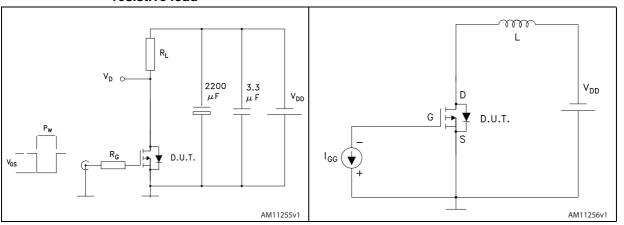
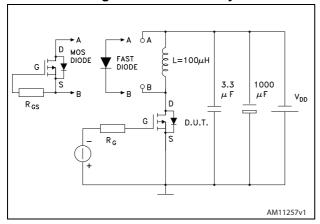


Figure 15. Test circuit for inductive load switching and diode recovery times



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.



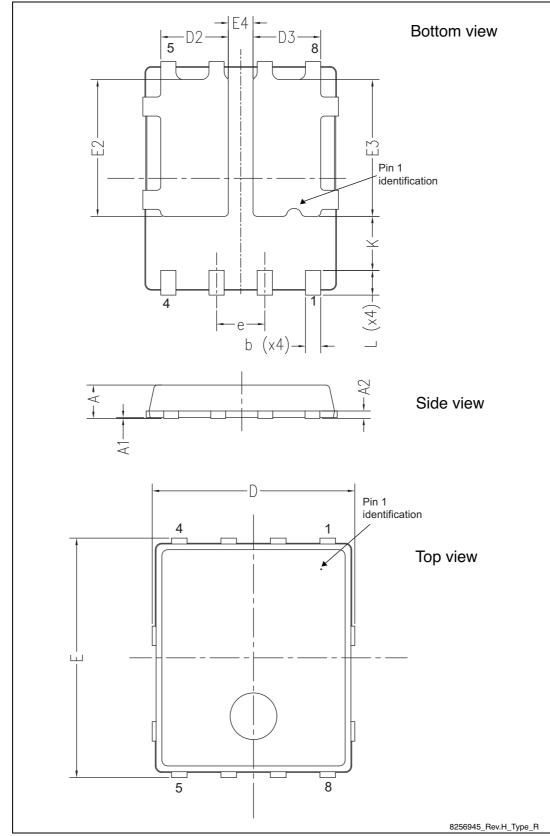


Figure 16. PowerFLAT™ 5x6 double island type R-A drawing

577

Table 8. PowerFLAT™ 5x6 double island type R-A mechanical data

Def		Dimensions (mm)	
Ref.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D		5.20	
E		6.15	
D2	1.68		1.88
E2	3.50		3.70
D3	1.68		1.88
E3	3.50		3.70
E4	0.55		0.75
е		1.27	
L	0.60		0.80
K	1.275		1.575



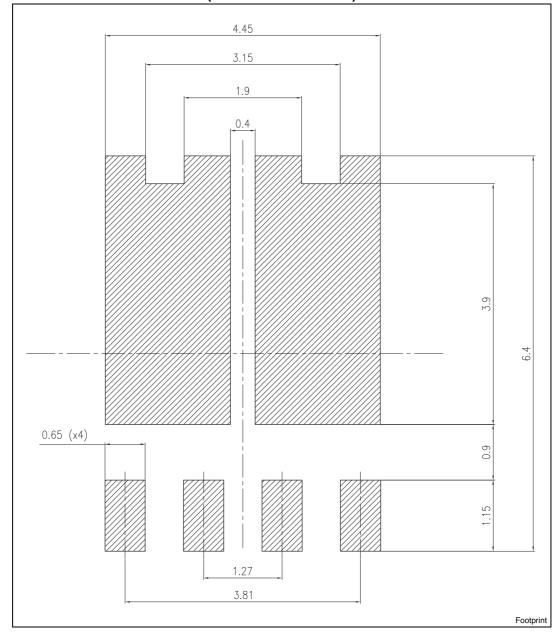


Figure 17. PowerFLAT[™] 5x6 double island type R-A drawing recommended footprint (dimensions are in mm)

STL13DP10F6 Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
19-Nov-2012	1	First release.
30-May-2014	2	 Document status promoted from target to production data Modified: title Modified: R_{DS(on)} typical value in <i>Table 4</i>, <i>5</i>, <i>6</i>, 7 and 8 Added: Section 2.1: Electrical characteristics (curves) Updated: Section 4: Package mechanical data Minor text changes

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